

150V N-Ch Power MOSFET
Feature

- ◇ High Speed Power Switching
- ◇ Enhanced Body diode dv/dt capability
- ◇ Enhanced Avalanche Ruggedness
- ◇ 100% UIS Tested, 100% Rg Tested
- ◇ Lead Free

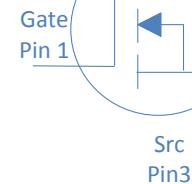
V_{DS}	150	V
$R_{DS(on),typ}$	TO-263	5.75 mΩ
$R_{DS(on),typ}$	TO-247	5.92 mΩ
$R_{DS(on),typ}$	TO-220	6.0 mΩ
I_D	170	A

Application

- ◇ Synchronous Rectification in SMPS
- ◇ Hard Switching and High Speed Circuit
- ◇ Power Tools
- ◇ UPS
- ◇ Motor Control

TO-263

TO-220

**Drain
Pin2**

TO-247

**Src
Pin3**

Part Number	Package	Marking
HGB072N15S	TO-263	GB072N15S
HGK072N15S	TO-247	GK072N15S
HGP072N15S	TO-220	GP072N15S

Absolute Maximum Ratings at $T_i=25^\circ\text{C}$ (unless otherwise specified)

Parameter	Symbol	Conditions	Value	Unit
Continuous Drain Current	I_D	$T_C=25^\circ\text{C}$	170	A
		$T_C=100^\circ\text{C}$	120	
Drain to Source Voltage	V_{DS}	-	150	V
Gate to Source Voltage	V_{GS}	-	± 20	V
Pulsed Drain Current	I_{DM}	-	550	A
Avalanche Energy, Single Pulse	E_{AS}	$L=0.4\text{mH}, T_C=25^\circ\text{C}$	1620	mJ
Power Dissipation	P_D	$T_C=25^\circ\text{C}$	429	W
Operating and Storage Temperature	T_J, T_{stg}	-	-55 to 175	°C

Absolute Maximum Ratings

Parameter	Symbol	Max	Unit
Thermal Resistance Junction-Case	$R_{\Theta JC}$	0.35	°C/W
Thermal Resistance Junction-Ambient	$R_{\Theta JA}$	60	°C/W

Electrical Characteristics at $T_j=25^\circ\text{C}$ (unless otherwise specified)
Static Characteristics

Parameter	Symbol	Conditions	Value			Unit	
			min	typ	max		
Drain to Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_D=250\mu\text{A}$	150	-	-	V	
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}}=V_{\text{DS}}, I_D=250\mu\text{A}$	2	3	4		
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=150\text{V}, T_j=25^\circ\text{C}$	-	-	1	μA	
		$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=150\text{V}, T_j=100^\circ\text{C}$	-	-	100		
Gate to Source Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 100	nA	
Drain to Source on Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=10\text{V}, I_D=20\text{A}$	TO-263	-	5.8	6.9	$\text{m}\Omega$
			TO-247	-	5.9	7.1	
			TO-220	-	6.0	7.2	
Transconductance	g_{fs}	$V_{\text{DS}}=5\text{V}, I_D=20\text{A}$	-	120	-	S	
Gate Resistance	R_G	$V_{\text{GS}}=0\text{V}, V_{\text{DS}} \text{ Open}, f=1\text{MHz}$	-	0.7	-	Ω	

Dynamic Characteristics

Input Capacitance	C_{iss}	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=75\text{V}, f=1\text{MHz}$	-	7200	-	pF
Output Capacitance	C_{oss}		-	525	-	
Reverse Transfer Capacitance	C_{rss}		-	20	-	
Total Gate Charge	Q_g	$V_{\text{DD}}=75\text{V}, I_D=20\text{A}, V_{\text{GS}}=10\text{V}$	-	110	-	nC
Gate to Source Charge	Q_{gs}		-	23	-	
Gate to Drain (Miller) Charge	Q_{gd}		-	16	-	
Turn on Delay Time	$t_{\text{d}(\text{on})}$		-	TBD	-	
Rise time	t_r	$V_{\text{DD}}=75\text{V}, I_D=20\text{A}, V_{\text{GS}}=10\text{V}, R_G=10\Omega,$	-	TBD	-	ns
Turn off Delay Time	$t_{\text{d}(\text{off})}$		-	TBD	-	
Fall Time	t_f		-	TBD	-	

Reverse Diode Characteristics

Diode Forward Voltage	V_{SD}	$V_{\text{GS}}=0\text{V}, I_F=20\text{A}$	-	0.9	1.2	V
Reverse Recovery Time	t_{rr}	$V_R=75\text{V}, I_F=30\text{A}, dI_F/dt=100\text{A}/\mu\text{s}$	-	TBD	-	ns
Reverse Recovery Charge	Q_{rr}		-	TBD	-	nC